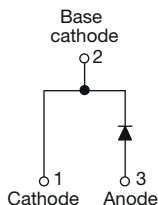


## Fast Soft Recovery Rectifier Diode, 10 A



2L TO-220AC



### FEATURES

- Glass passivated pellet chip junction
- Meets JESD 201 class 1A whisker test
- Flexible solution for reliable AC power rectification
- High surge, low  $V_F$  rugged blocking diode for DC charging stations
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- On-board and off-board EV/HEV battery chargers
- Input rectification

### DESCRIPTION

The VS-10ETF12THM3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

### PRIMARY CHARACTERISTICS

|                       |             |
|-----------------------|-------------|
| $I_{F(AV)}$           | 10 A        |
| $V_R$                 | 1200 V      |
| $V_F$ at $I_F$        | 1.33 V      |
| $I_{FSM}$             | 140 A       |
| $t_{rr}$              | 80 ns       |
| $T_J$ max.            | 150 °C      |
| Snap factor           | 0.6         |
| Package               | 2L TO-220AC |
| Circuit configuration | Single      |

### MAJOR RATINGS AND CHARACTERISTICS

| SYMBOL      | CHARACTERISTICS     | VALUES      | UNITS |
|-------------|---------------------|-------------|-------|
| $V_{RRM}$   |                     | 1200        | V     |
| $I_{F(AV)}$ | Sinusoidal waveform | 10          | A     |
| $I_{FSM}$   |                     | 140         |       |
| $t_{rr}$    | 1 A, 100 A/μs       | 80          | ns    |
| $V_F$       | 10 A, $T_J = 25$ °C | 1.33        | V     |
| $T_J$       |                     | -40 to +150 | °C    |

### VOLTAGE RATINGS

| PART NUMBER    | $V_{RRM}$ , MAXIMUM PEAK REVERSE VOLTAGE<br>V | $V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE<br>V | $I_{RRM}$ AT 150 °C<br>mA |
|----------------|-----------------------------------------------|--------------------------------------------------------------|---------------------------|
| VS-10ETF12THM3 | 1200                                          | 1300                                                         | 4                         |

### ABSOLUTE MAXIMUM RATINGS

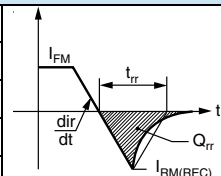
| PARAMETER                                           | SYMBOL        | TEST CONDITIONS                                | VALUES | UNITS             |
|-----------------------------------------------------|---------------|------------------------------------------------|--------|-------------------|
| Maximum average forward current                     | $I_{F(AV)}$   | $T_C = 125$ °C, 180° conduction half sine wave | 10     | A                 |
| Maximum peak one cycle non-repetitive surge current | $I_{FSM}$     | 10 ms sine pulse, rated $V_{RRM}$ applied      | 115    |                   |
|                                                     |               | 10 ms sine pulse, no voltage reapplied         | 140    |                   |
| Maximum $I^2t$ for fusing                           | $I^2t$        | 10 ms sine pulse, rated $V_{RRM}$ applied      | 66     | A <sup>2</sup> s  |
|                                                     |               | 10 ms sine pulse, no voltage reapplied         | 94     |                   |
| Maximum $I^2\sqrt{t}$ for fusing                    | $I^2\sqrt{t}$ | $t = 0.1$ to 10 ms, no voltage reapplied       | 940    | A <sup>2</sup> √s |

**ELECTRICAL SPECIFICATIONS**

| PARAMETER                       | SYMBOL      | TEST CONDITIONS                          |                               | VALUES | UNITS            |
|---------------------------------|-------------|------------------------------------------|-------------------------------|--------|------------------|
| Maximum forward voltage drop    | $V_{FM}$    | 10 A, $T_J = 25\text{ }^{\circ}\text{C}$ |                               | 1.33   | V                |
| Forward slope resistance        | $r_t$       | $T_J = 150\text{ }^{\circ}\text{C}$      |                               | 22.9   | $\text{m}\Omega$ |
| Threshold voltage               | $V_{F(TO)}$ |                                          |                               | 0.96   | V                |
| Maximum reverse leakage current | $I_{RM}$    | $T_J = 25\text{ }^{\circ}\text{C}$       | $V_R = \text{Rated } V_{RRM}$ | 0.1    | mA               |
|                                 |             | $T_J = 150\text{ }^{\circ}\text{C}$      |                               | 4      |                  |

**RECOVERY CHARACTERISTICS**

| PARAMETER                | SYMBOL   | TEST CONDITIONS                                                             | VALUES | UNITS         |
|--------------------------|----------|-----------------------------------------------------------------------------|--------|---------------|
| Reverse recovery time    | $t_{rr}$ | $I_F$ at 10 A <sub>pk</sub><br>25 A/ $\mu\text{s}$<br>25 $^{\circ}\text{C}$ | 310    | ns            |
| Reverse recovery current | $I_{rr}$ |                                                                             | 4.7    | A             |
| Reverse recovery charge  | $Q_{rr}$ |                                                                             | 1.05   | $\mu\text{C}$ |
| Typical snap factor      | S        |                                                                             | 0.6    |               |

**THERMAL - MECHANICAL SPECIFICATIONS**

| PARAMETER                                      | SYMBOL                            | TEST CONDITIONS                      | VALUES      | UNITS                  |
|------------------------------------------------|-----------------------------------|--------------------------------------|-------------|------------------------|
| Maximum junction and storage temperature range | T <sub>J</sub> , T <sub>Stg</sub> |                                      | -40 to +150 | °C                     |
| Maximum thermal resistance junction to case    | R <sub>thJC</sub>                 | DC operation                         | 1.5         | °C/W                   |
| Maximum thermal resistance junction to ambient | R <sub>thJA</sub>                 |                                      | 62          |                        |
| Typical thermal resistance, case to heatsink   | R <sub>thCS</sub>                 | Mounting surface, smooth and greased | 0.5         |                        |
| Approximate weight                             |                                   |                                      | 2           | g                      |
|                                                |                                   |                                      | 0.07        | oz.                    |
| Mounting torque                                | minimum                           |                                      | 6 (5)       | kgf · cm<br>(lbf · in) |
|                                                | maximum                           |                                      | 12 (10)     |                        |
| Marking device                                 |                                   | Case style 2L TO-220AC               | 10ETF12TH   |                        |

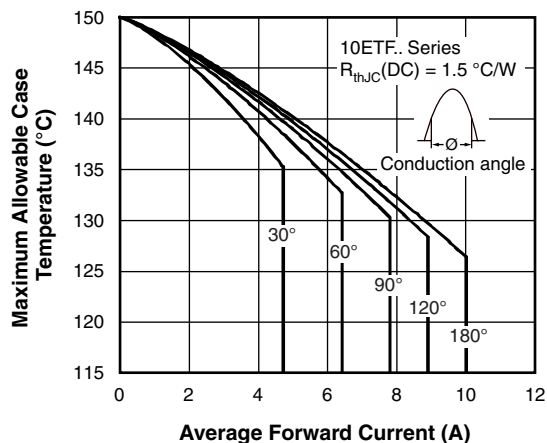


Fig. 1 - Current Rating Characteristics

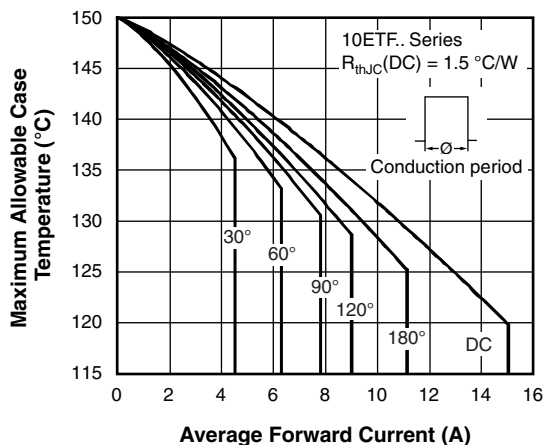


Fig. 2 - Current Rating Characteristics

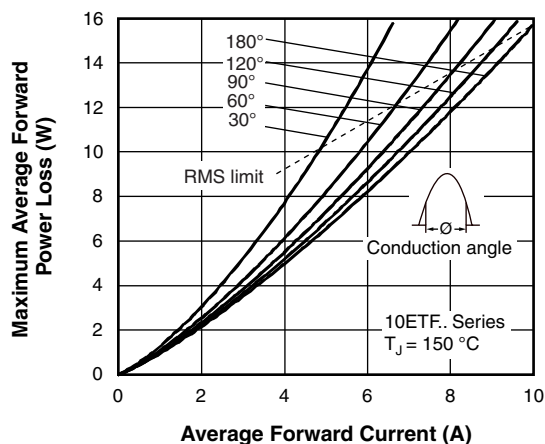


Fig. 3 - Forward Power Loss Characteristics

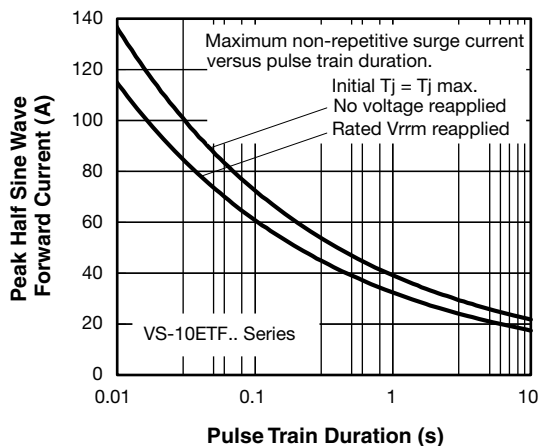


Fig. 6 - Maximum Non-Repetitive Surge Current

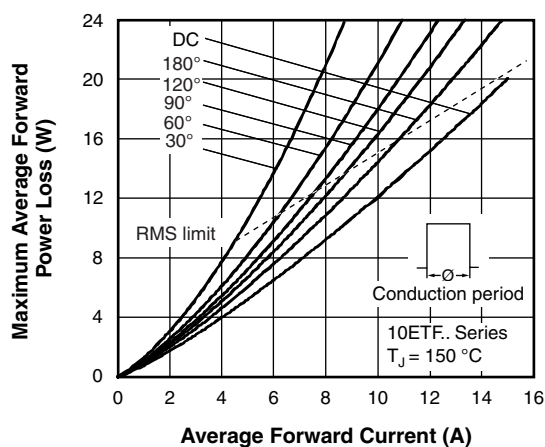


Fig. 4 - Forward Power Loss Characteristics

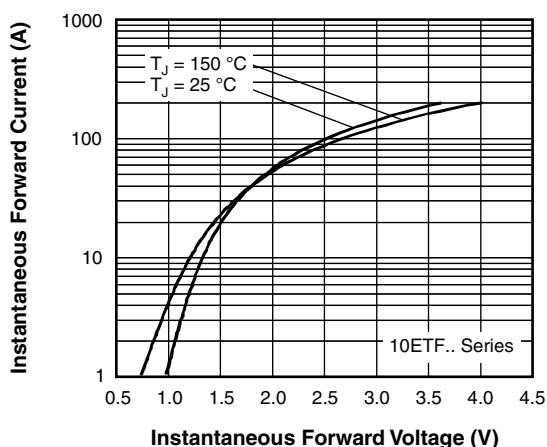


Fig. 7 - Forward Voltage Drop Characteristics

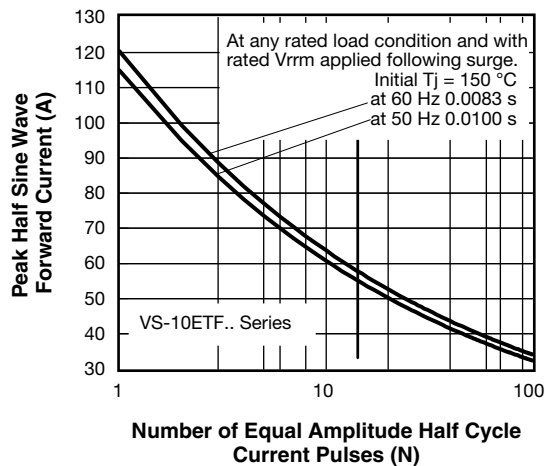
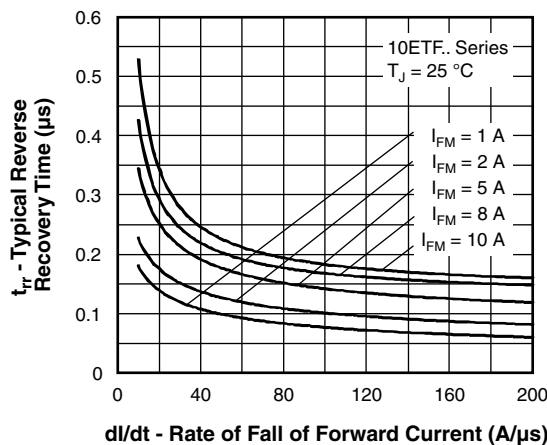
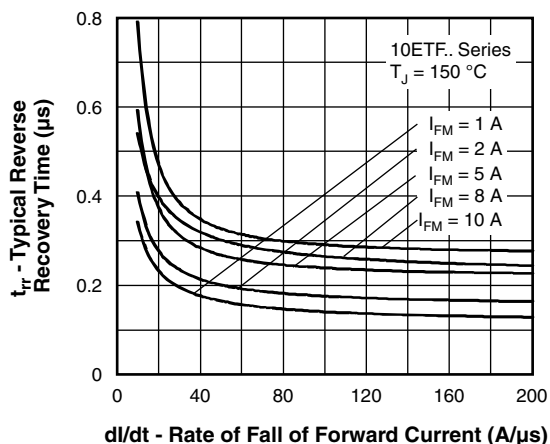
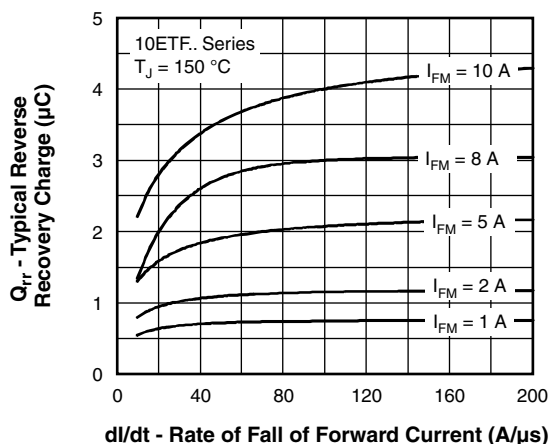
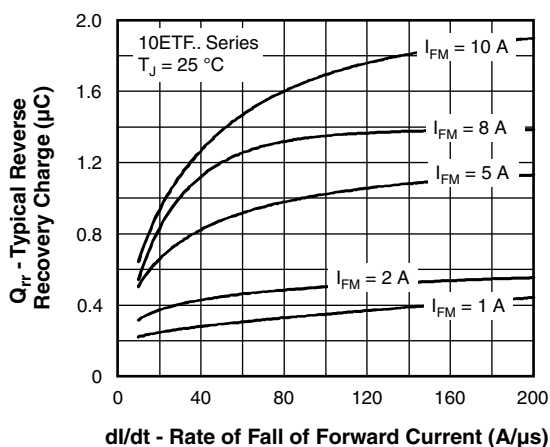
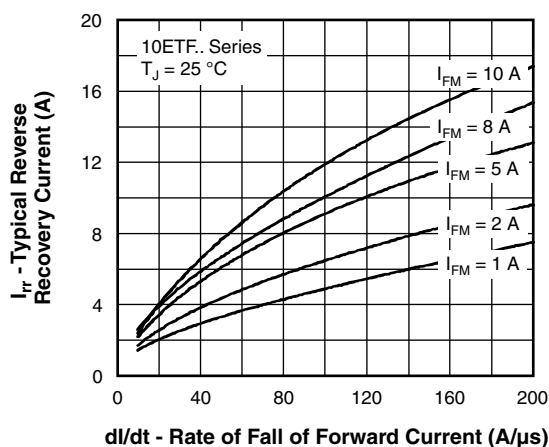
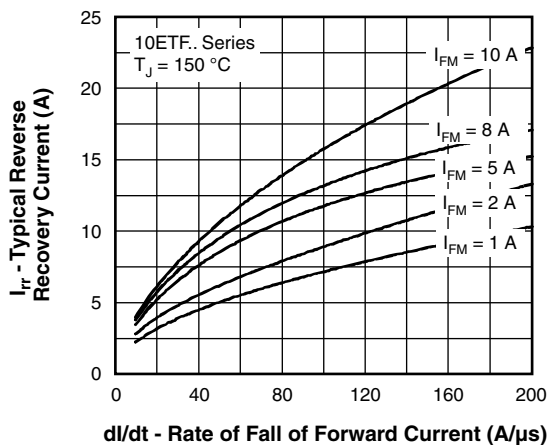
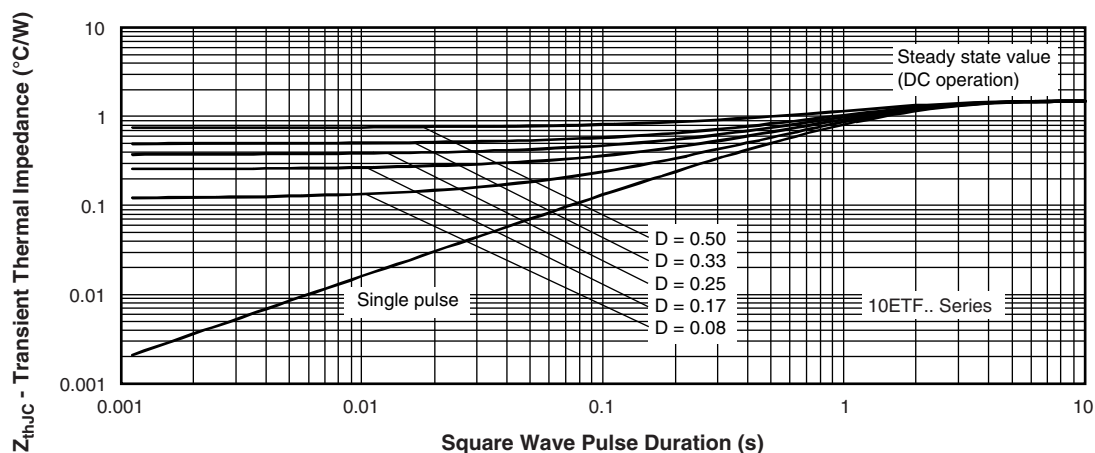


Fig. 5 - Maximum Non-Repetitive Surge Current


Fig. 8 - Recovery Time Characteristics,  $T_J = 25\text{ }^{\circ}\text{C}$


Fig. 9 - Recovery Time Characteristics,  $T_J = 150\text{ }^{\circ}\text{C}$ 

Fig. 11 - Recovery Charge Characteristics,  $T_J = 150\text{ }^{\circ}\text{C}$ 

Fig. 10 - Recovery Charge Characteristics,  $T_J = 25\text{ }^{\circ}\text{C}$ 

Fig. 12 - Recovery Current Characteristics,  $T_J = 25\text{ }^{\circ}\text{C}$ 

Fig. 13 - Recovery Current Characteristics,  $T_J = 150\text{ }^{\circ}\text{C}$


Fig. 14 - Thermal Impedance  $Z_{thJC}$  Characteristics

### ORDERING INFORMATION TABLE

|             |            |           |          |          |          |           |          |          |           |
|-------------|------------|-----------|----------|----------|----------|-----------|----------|----------|-----------|
| Device code | <b>VS-</b> | <b>10</b> | <b>E</b> | <b>T</b> | <b>F</b> | <b>12</b> | <b>T</b> | <b>H</b> | <b>M3</b> |
|             | ①          | ②         | ③        | ④        | ⑤        | ⑥         | ⑦        | ⑧        | ⑨         |

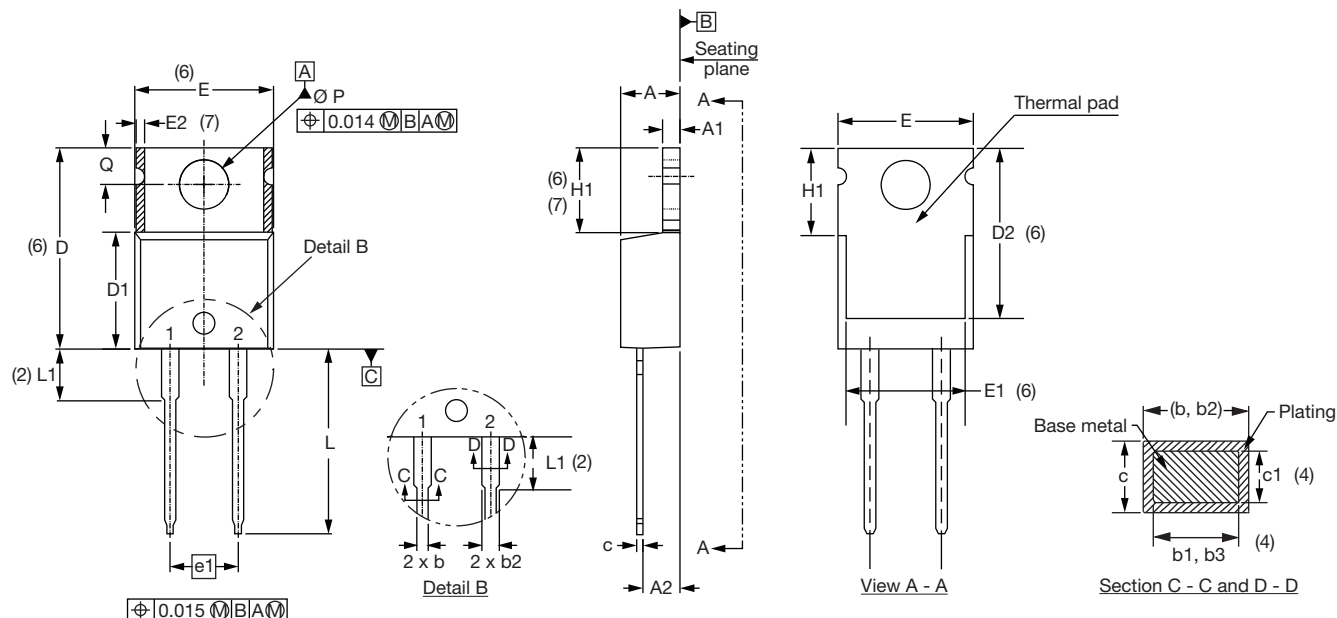
- 1** - Vishay Semiconductors product
- 2** - Current rating (10 = 10 A)
- 3** - Circuit configuration:  
E = 2L TO-220AC
- 4** - Package:  
T = TO-220
- 5** - Type of silicon:  
F = fast soft recovery rectifier
- 6** - Voltage code x 100 =  $V_{RRM}$  ——— **12 = 1200 V**
- 7** -
  - None = TO-220AB
  - T = true pin TO-220
- 8** - H = AEC-Q101 qualified
- 9** - Environmental digit:  
M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) |                  |                        |                         |
|--------------------------------|------------------|------------------------|-------------------------|
| PREFERRED P/N                  | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION   |
| VS-10ETF12THM3                 | 50               | 1000                   | Antistatic plastic tube |

| LINKS TO RELATED DOCUMENTS |                                                                        |
|----------------------------|------------------------------------------------------------------------|
| Dimensions                 | <a href="http://www.vishay.com/doc?96069">www.vishay.com/doc?96069</a> |
| Part marking information   | <a href="http://www.vishay.com/doc?95391">www.vishay.com/doc?95391</a> |

### 2L TO-220AC

**DIMENSIONS** in millimeters and inches



| SYMBOL | MILLIMETERS |       | INCHES |       | NOTES |
|--------|-------------|-------|--------|-------|-------|
|        | MIN.        | MAX.  | MIN.   | MAX.  |       |
| A      | 4.25        | 4.65  | 0.167  | 0.183 |       |
| A1     | 1.14        | 1.40  | 0.045  | 0.055 |       |
| A2     | 2.56        | 2.92  | 0.101  | 0.115 |       |
| b      | 0.69        | 1.01  | 0.027  | 0.040 |       |
| b1     | 0.38        | 0.97  | 0.015  | 0.038 | 4     |
| b2     | 1.20        | 1.73  | 0.047  | 0.068 |       |
| b3     | 1.14        | 1.73  | 0.045  | 0.068 | 4     |
| c      | 0.36        | 0.61  | 0.014  | 0.024 |       |
| c1     | 0.36        | 0.56  | 0.014  | 0.022 | 4     |
| D      | 14.85       | 15.25 | 0.585  | 0.600 | 3     |
| D1     | 8.38        | 9.02  | 0.330  | 0.355 |       |
| D2     | 11.68       | 12.88 | 0.460  | 0.507 | 6     |
| E      | 10.11       | 10.51 | 0.398  | 0.414 | 3, 6  |

| SYMBOL | MILLIMETERS |       | INCHES |       | NOTES |
|--------|-------------|-------|--------|-------|-------|
|        | MIN.        | MAX.  | MIN.   | MAX.  |       |
| E1     | 6.86        | 8.89  | 0.270  | 0.350 | 6     |
| E2     | -           | 0.76  | -      | 0.030 | 7     |
| e      | 2.41        | 2.67  | 0.095  | 0.105 |       |
| e1     | 4.88        | 5.28  | 0.192  | 0.208 |       |
| H1     | 6.09        | 6.48  | 0.240  | 0.255 | 6, 7  |
| L      | 13.52       | 14.02 | 0.532  | 0.552 |       |
| L1     | 3.32        | 3.82  | 0.131  | 0.150 | 2     |
| Ø P    | 3.54        | 3.73  | 0.139  | 0.147 |       |
| Q      | 2.60        | 3.00  | 0.102  | 0.118 |       |

#### Notes

- Dimensioning and tolerancing as per ASME Y14.5M-1994
- Lead dimension and finish uncontrolled in L1
- Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Dimension b1, b3 and c1 apply to base metal only
- Controlling dimension: inches
- Thermal pad contour optional within dimensions E, H1, D2 and E1
- Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- Outline conforms to JEDEC® TO-220, except D2, where JEDEC® minimum is 0.480".



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